



10/608,059

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Brian Taggert et al.	Examiner:	Cathy Lam
Serial No.:	10/608,059	Group Art Unit:	1775
Filed:	June 27, 2003	Docket:	884.887US1
Title:	USE OF DIRECT GOLD SURFACE FINISH ON A COPPER WIRE-BOND SUBSTRATE, METHODS OF MAKING SAME, AND METHODS OF TESTING SAME (AS AMENDED)		
Assignee:	Intel Corporation	Customer Number:	21186

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
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AMENDMENT UNDER 37 C.F.R. § 1.312(a)

In response to the Notice of Allowance and Notice of Allowability mailed April 11, 2005, please amend the above-identified application as indicated on the next page.

Additionally, Applicants would like to point out that the Notice of Allowance incorrectly listed the title of the application as USE OF GOLD SURFACE FINISH ON A COPPER WIRE-BOND SUBSTRATE, METHOD OF MAKING SAME, AND METHODS OF TESTING SAME when it was amended in the Amendment and Response filed on September 21, 2004 as "USE OF DIRECT GOLD SURFACE FINISH ON A COPPER WIRE-BOND SUBSTRATE, METHOD OF MAKING SAME, AND METHODS OF TESTING SAME."